If you remove a CPU/Memory board, install a filler board to maintain proper cooling of the system.

**Installing the CPU/Memory Filler Board**

1. **Remove the CPU/Memory board from the system:**
   Refer to your system’s service manual. Observe the precautions listed in the service manual.

2. **Install the CPU/Memory filler board.**
   
   a. **Make sure that the ejector levers of the filler board are in the open position.**
      They should be oriented 90 degrees straight out from the board during the entire procedure.

   ![Caution – DO NOT FORCE any board into a slot. Doing so can damage the board and system. The board should insert and seat smoothly. If it binds, remove the board and inspect the card cage slot for any obvious obstructions.]

   b. **Hold the sides of the filler board and gently insert the board into the grooves until the antigravity clutch is engaged.**
      The antigravity clutch holds the board in position so that it can be released without the board sliding down into the system.
c. Slowly push down from the center top of the CPU/Memory filler board as shown below, until the top face of the board is approximately three to four inches from the top of chassis.

d. When the board is approximately three to four inches inch from the top of the chassis, change your grip and grasp the ejector levers so that they are oriented in the vertical position, 90 degrees straight out from the board.
Caution – Metal pins on the underside of the ejector levers help to cushion the CPU/Memory filler board after the antigravity clutch is released. If the levers are not 90 degrees straight out from the top of the board, there is a chance the connectors could be damaged.

Note – Simultaneously with the board nearing its fully seated position, the ejectors will be forced mechanically to a position approximately 45 degrees towards board center.

e. To complete the seating, lower the board using the ejector levers until the levers are forced approximately 45 degrees towards the inside of the board.

f. Reposition your grip on the levers and then push down on the levers to lock them into place.

Removing the Filler Board

1. Prepare the system for the installation of a CPU/Memory board.
   Refer to the service manual for detailed instructions. Observe the precautions listed in the manual.

2. Remove the filler board:
   a. Unlock the ejector levers on the CPU/Memory Filler board with a Phillips no. 2 screwdriver.
      The ejectors will pop out slightly.
   b. Raise the ejector levers simultaneously until they are 90 degrees straight out from the board.
   c. Grasp the ejector levers and pull upwards to raise the CPU/Memory filler board out of the system.

3. Install a CPU/Memory board in the empty slot.

Caution – To maintain proper cooling of the system, do not allow the slot to remain empty.
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Sun Fire E2900/V1280 and Netra 1280 Systems CPU/Memory Filler Board Installation Guide, part number 817-2676-11

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Part No. 817-2676-11, Rev. A
April 2004